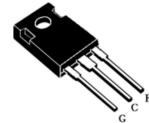


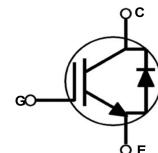
Features

- Low Gate charge
- FS Technology
- V_{CE(sat)} = 1.7V @ IC = 20A
- High Input Impedance
- Short circuit withstand time 10 µs



Applications

- PFC
- UPS
- Inverter



Absolute Maximum Ratings

Parameter		Symbol	Value	Unit
Collector-emitter voltage		V _{CES}	1200	V
Gate-emitter voltage		V _{GES}	±30	
Collector current	T _C =25°C	I _C	40	A
	T _C =100°C		20	
Pulsed collector current, pulse time limited by T _{jmax}		I _{CM}	60	
Diode forward current @ T _C = 100°C		I _F	20	
Diode pulsed current, Pulse time limited by T _{jmax}		I _{FM}	120	
Power dissipati	T _C =25°C	P _D	227	W
	T _C =100°C		132	
Operating Junction and storage temperature rang		T _J	-55 to150	°C
		T _{stg}	-55 to150	

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal resistance junction-to-ambien	R _{θJA}	62.5	°C/W
Thermal resistance junction-to-case for IGBT	R _{θJC}	0.55	
Thermal resistance junction-to-case for Diod	R _{θJC}	0.65	

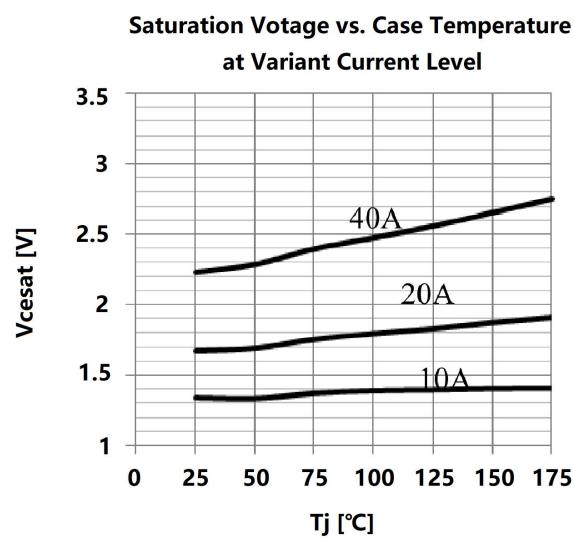
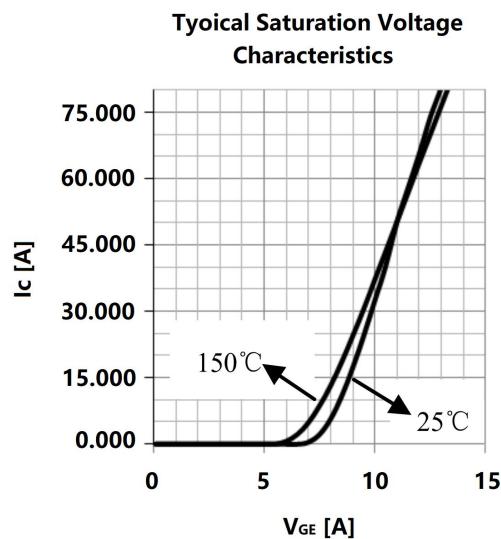
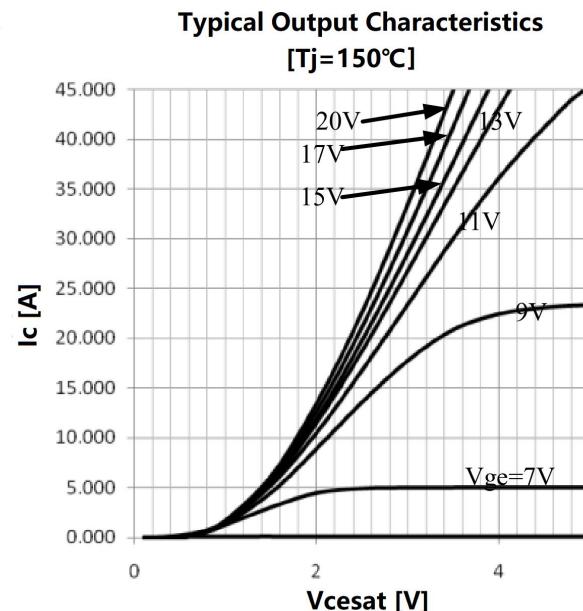
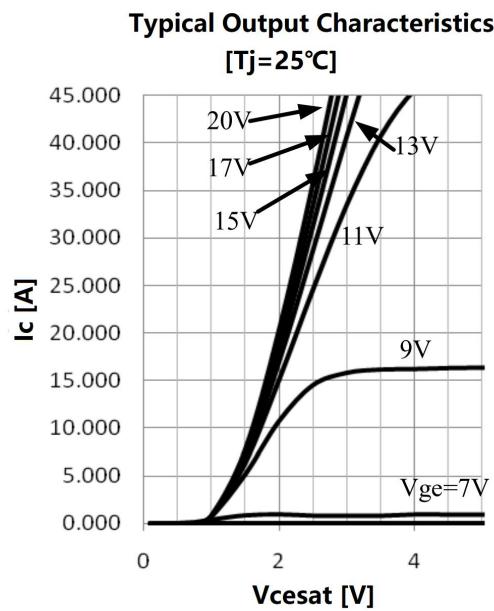
Electrical Characteristics ($T_c = 25^\circ\text{C}$ unless otherwise specified)

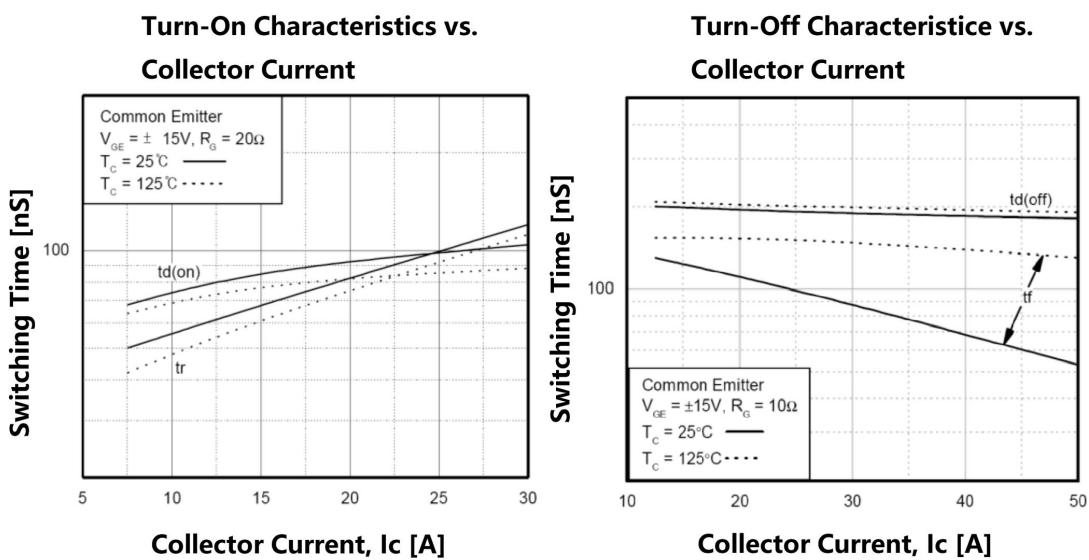
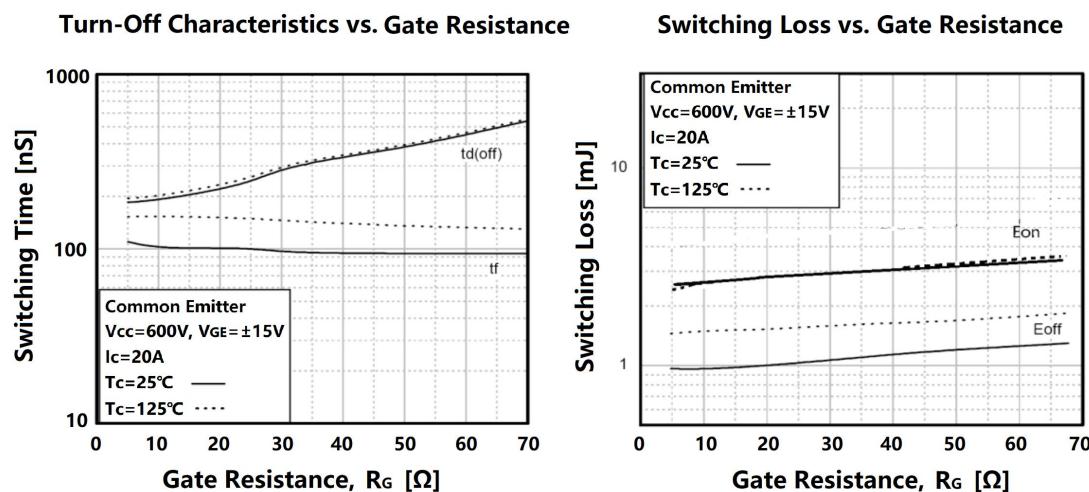
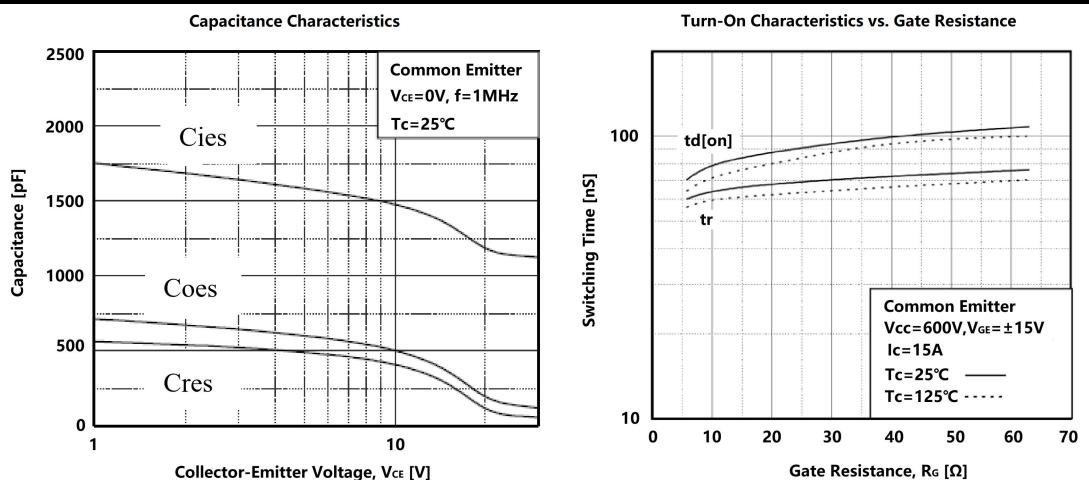
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Collector-emitter breakdown voltage	BV_{CES}	$I_C = 500 \mu\text{A}, V_{GE} = 0\text{V}$	1200	-	-	V
Gate-emitter threshold voltage	$V_{GE(\text{th})}$	$V_{CE} = V_{GE}, I_C = 250 \mu\text{A}$	4.5	-	6.5	
Zero gate voltage collector current	I_{CES}	$V_{CE} = 1200\text{V}, V_{GE} = 0\text{V}$	-		200	μA
Gate-emitter leakage current	I_{GES}	$V_{GE} = 20\text{V}, V_{CE} = 0\text{V}$	-	-	100	nA
Collector-emitter saturation voltage	$V_{CE(\text{sat})}$	$I_C = 20\text{A} V_{GE} = 15\text{V} T_c = 25^\circ\text{C}$	-	1.7	2.0	V
		$I_C = 20\text{A}, V_{GE} = 15\text{V}, T_c = 150^\circ\text{C}$	-	2.0	-	
Dynamic and Switching Characteristics						
Total gate charge	Q_g	$V_{CE} = 600\text{V}, I_C = 20\text{A}, V_{GE} = 15\text{V}$ $V_{GE} = 15\text{V}, V_{CC} = 600\text{V}, I_C = 20\text{A}, R_G = 10\Omega$ Inductive Load, $T_c = 25^\circ\text{C}$	-	115	-	nC
Reverse transfer capacitance	C_{res}		-	92	-	
Output capacitance	C_{oes}		-	128	-	
Turn-on delay time	$t_{d(on)}$		-	90	-	
Rise time	t_r		-	75	-	nS
Turn-off delay time	$t_{d(off)}$		-	210	-	
Fall time	t_f		-	100	-	
Turn-on switching energy	E_{on}		-	2.8	-	mJ
Turn-off switching energy	E_{off}		-	1.1	-	
Total switching energy	E_{ts}		-	3.9	-	
Diode Characteristics ($T_c = 25^\circ\text{C}$ unless otherwise specified)						
Forward voltage	V_F	$I_F=20\text{A}, T_c=25^\circ\text{C}$	-	1.7	2.75	V
		$I_F=20\text{A}, T_c=125^\circ\text{C}$	-	1.55	-	
Reverse recovery time	t_{rr}	$I_F=20\text{A}, di/dt=100\text{A}/\mu\text{s}$ $T_c=25^\circ\text{C}$	-	227	-	nS
Reverse recovery current	I_{rr}		-	4.6	-	A
Reverse recovery charge	Q_{rr}		-	1200	-	nC

Notes:

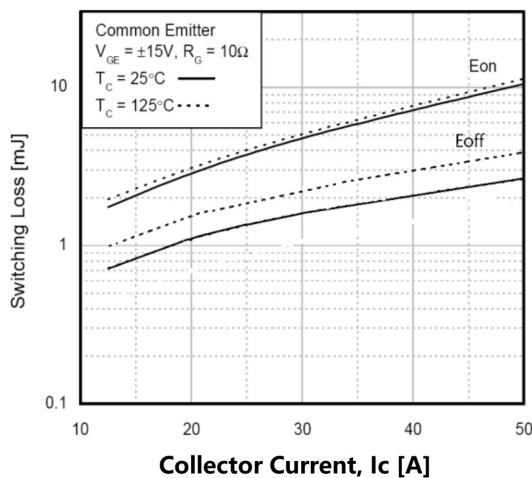
- 1: Pulse width limited by maximum junction temperature
- 2: Allowed number of short circuits: <1000; time between short circuits: >1s.
- 3: Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$
- 4: Essentially independent of operating temperature

Typical Performance Characteristic

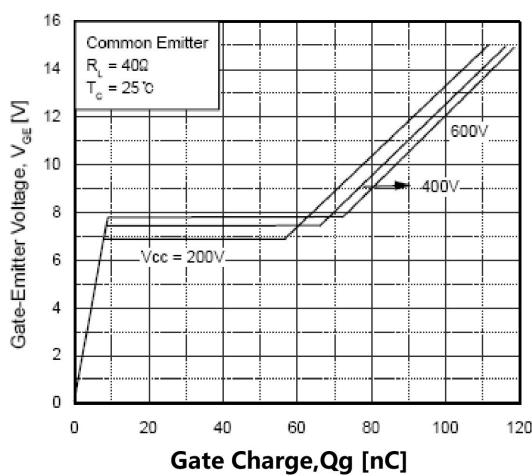




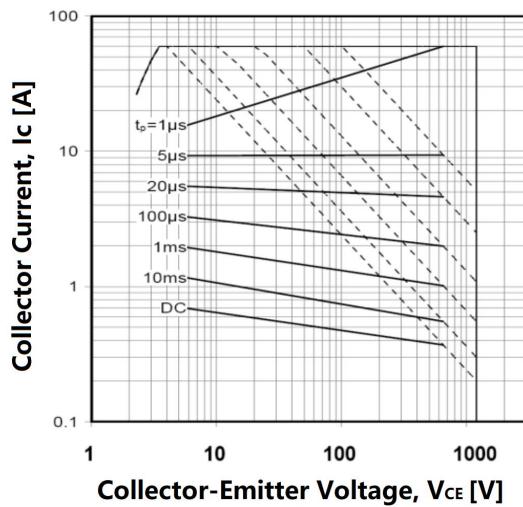
Switching Loss vs. Collector Current



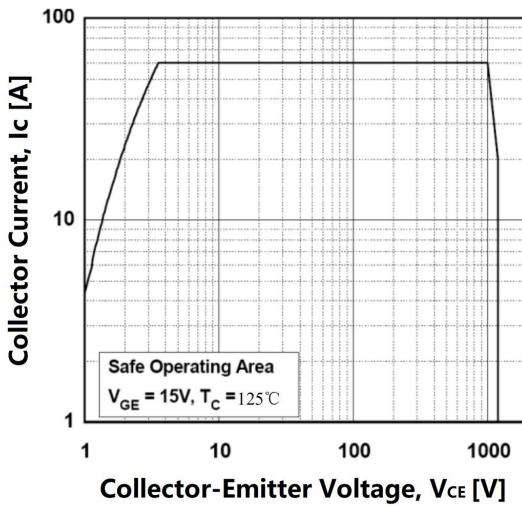
Gate Charge Characteristics



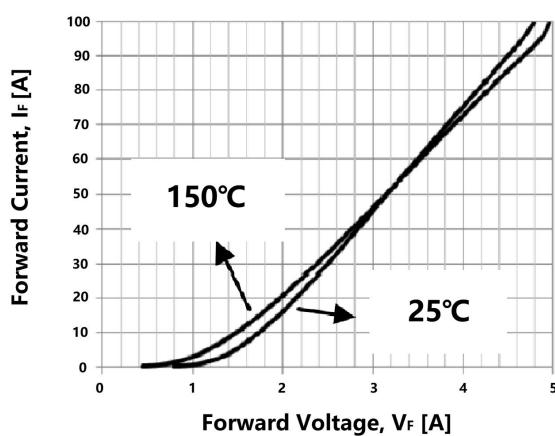
SOA Characteristics



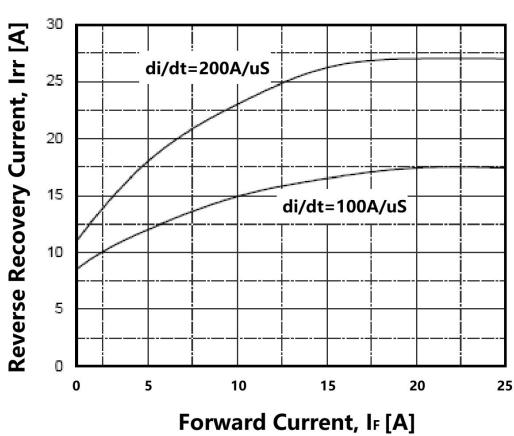
Turn-Off SOA

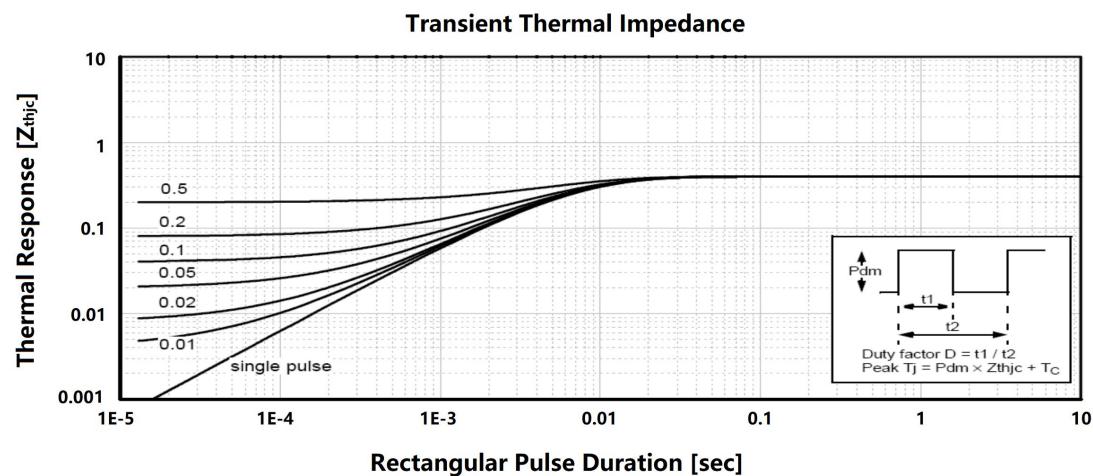
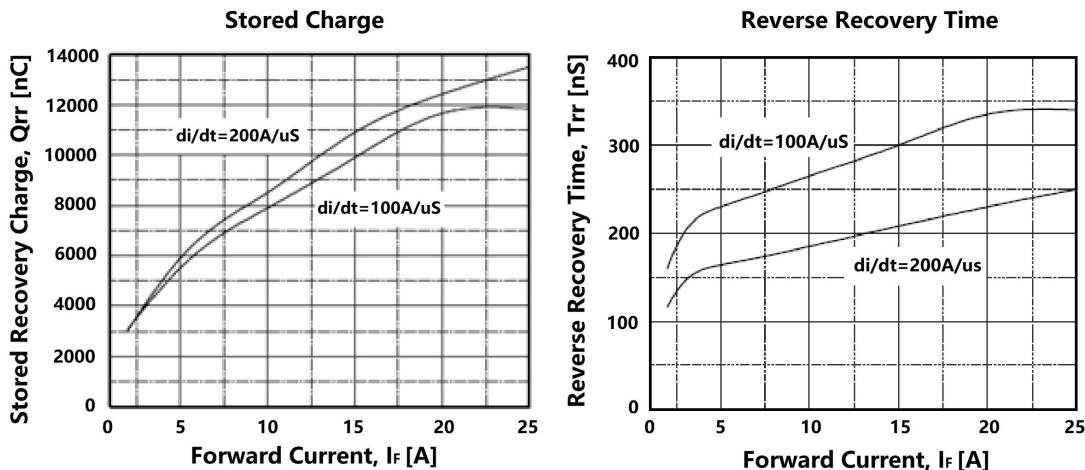


Forward Characteristics

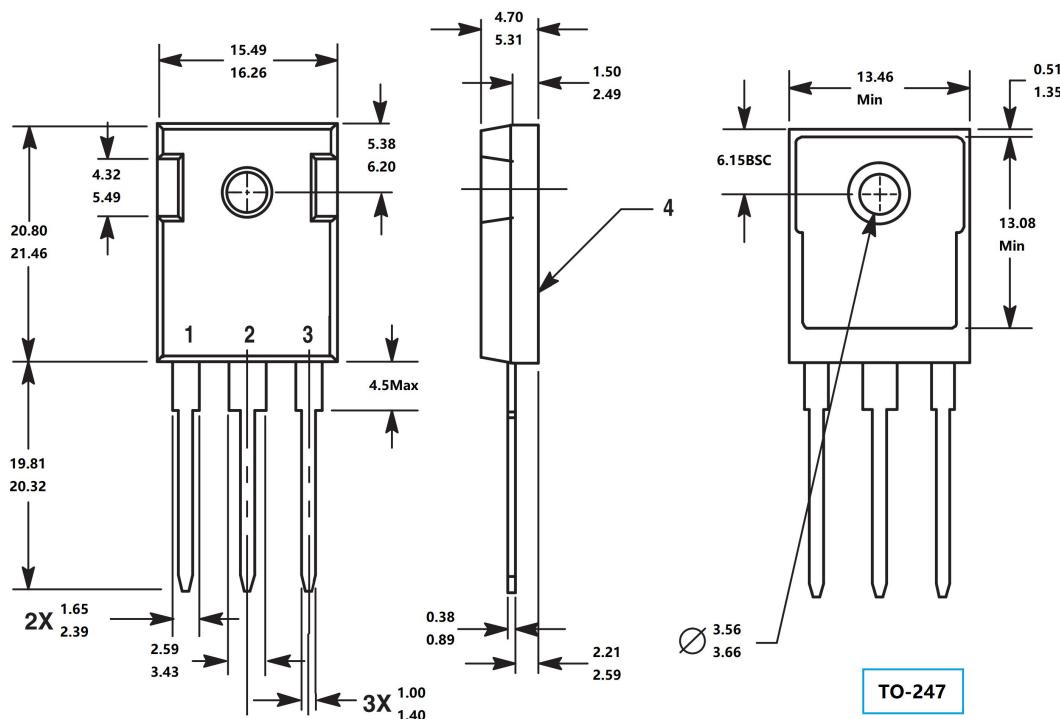


Reverse Recovery Current





Package outline dimension



TO-247